

[illegible]

TMAX-1335-XXX-M Molded Power Inductor

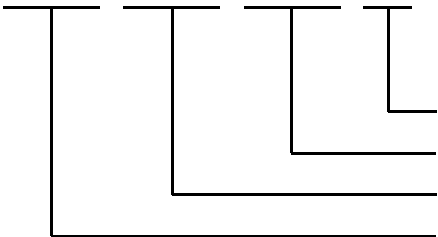
Features

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-
-
-
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-

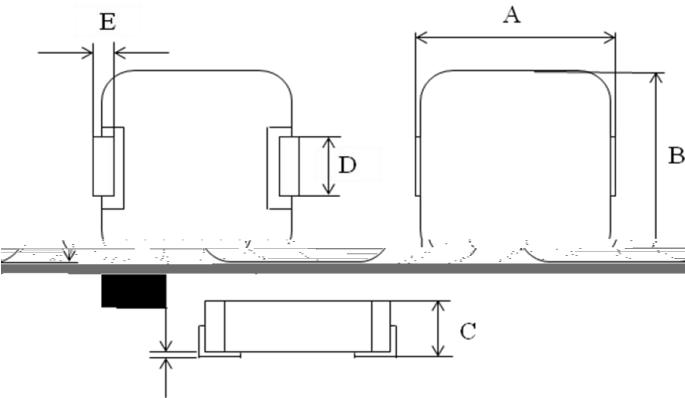
Applications

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-
-
-
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Product Description



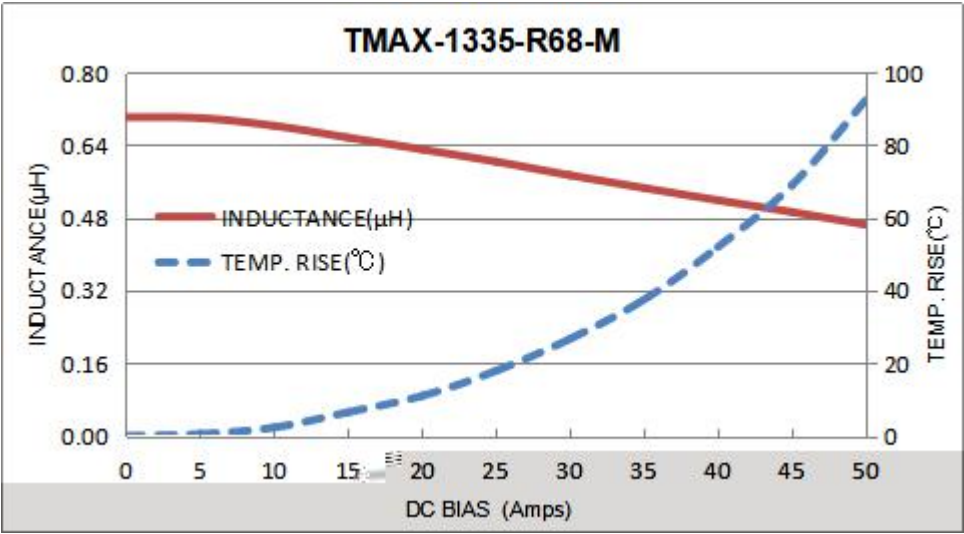
Dimensions



	13.8Max
	12.7±0.2
	3.5 Max.
	3.7±0.5
	2.3±0.5
	0~0.20

TDG HOLDING CO., LTD.

Inductance and Temperature Rise vs. DC Current



Reliability:

Item	Test Method	Specification and Requirement
	<div>±</div> <div>±</div> <div>±</div>	
		<div>±</div>

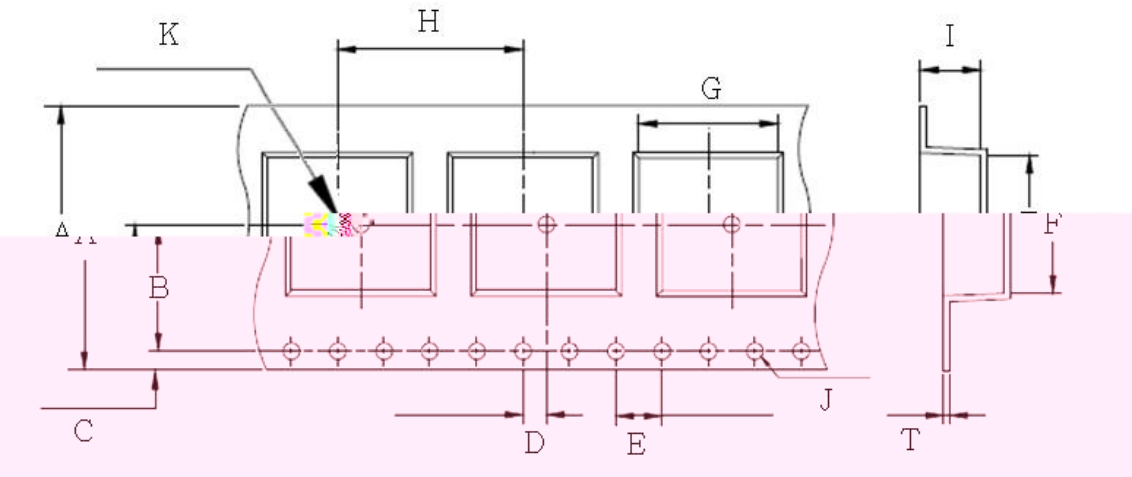


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C : A1
:

Reliability:

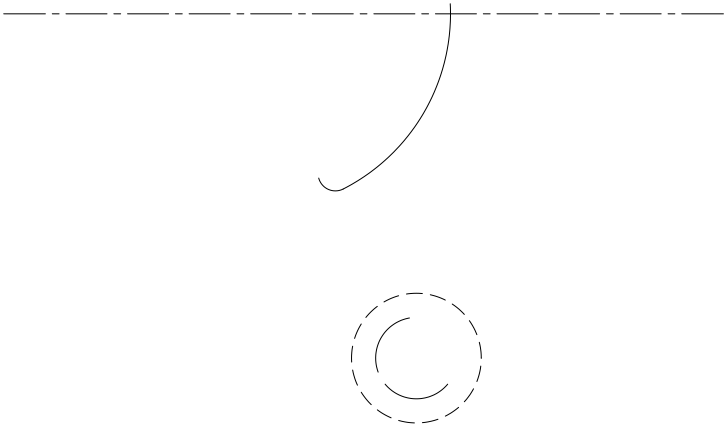
Packaging Dimensions



±	±	±	±	±	±
±	±	±	±	±	±

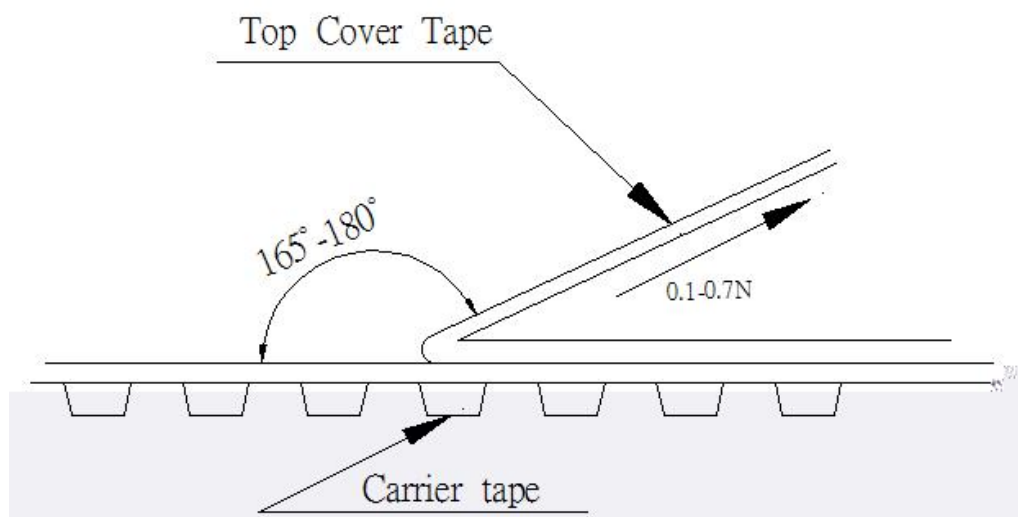
Reel Dimensions

±	±	



Peeling of top cover tape

-
-



Reflow Profile

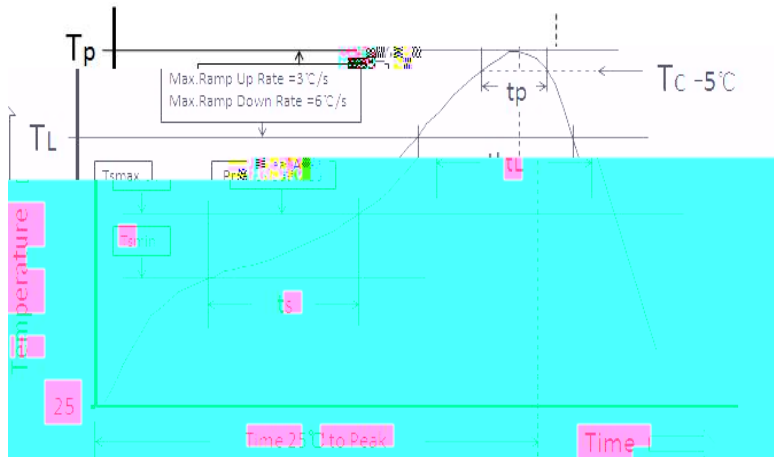


Table1-StandardSnPb Solder(Tc)

Package Thickness	Volume mm ³ 350	Volume mm ³ 350

Table2-Lead(Pb)Free Solder(Tc)

Package Thickness	Volume mm ³ 350	Volume mm ³ 350-2000	Volume mm ³ >2000

Reference JDEC J-STD-020(latest revision)

[illegible]

Numbers of taping

-

Label marking

-
-

Production Label

- ✓
- ✓
- ✓
- ✓
- ✓

Shipping Label

- ✓
- ✓
- ✓
- ✓
- ✓

Care note for use

➤ Storage Condition

➤ Use Temperature

- ✓
- ✓

- ✓
- ✓

➤ Model

➤ Drop



Care note for Safety

